TPS73801 1.0A 低ノイズ、高速過渡応答、低ドロップアウト レギュレータ

1 特長

- 高速過渡応答に最適化
- 出力電流:1.0A
- ドロップアウト電圧:300mV
- 低ノイズ:45μV_{RMS} (10Hz～100kHz)
- 静止電流:1mA
- 保護ダイオード不要
- ドロップアウト時の静止電流制御
- 可変出力電圧:1.21V ～ 20V
- シャットダウン時の静止電流:1μA 未満
- 10μF 出力コンデンサで安定
- セラミック コンデンサで安定動作
- バッテリ逆接続保護
- 逆電流なし
- 熱制限

2 アプリケーション

- 心電計 (ECG)
- 燃料電池インバータ
- ソース測定ユニット

3 説明

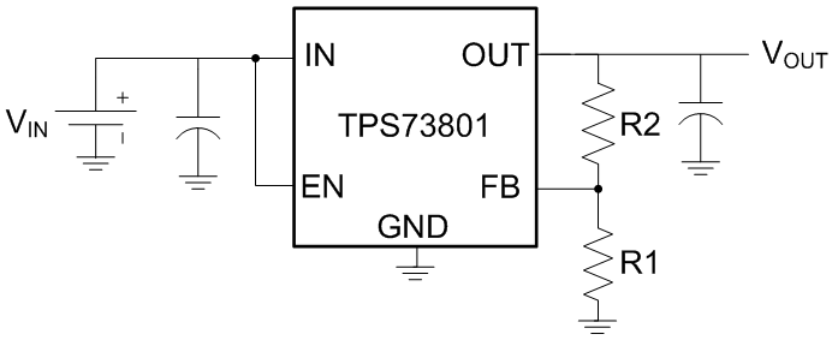
TPS73801 は、高速過渡応答に最適化された低ドロップアウト (LDO) レギュレータです。デバイスは、300mV のドロップアウト電圧で、1.0A の出力電流を供給できます。動作時の静止電流は 1mA で、シャットダウン時には 1μA 未満に低減します。静止電流は優れた制御がされており、多くの他のレギュレータで発生するドロップアウト時にも増加しません。高速な過渡応答に加え、TPS73801 レギュレータは非常に低い出力ノイズを実現しており、感度の高い RF 電源供給用途向けに設計されています。

出力電圧範囲は、1.21V～20V です。TPS73801 レギュレータは、10μF の出力コンデンサでも安定動作します。他のレギュレータのように ESR を追加しなくても、小さなセラミック コンデンサを使用できます。内部保護回路には、逆接続保護、電流制限、熱制限、および逆電流保護が含まれています。本デバイスは、1.21V のリファレンス電圧を持つ調整可能タイプとして提供されています。TPS73801 レギュレータは、6 ピンの TO-223 (DCQ) パッケージで提供されています。

パッケージ情報

部品番号	パッケージ (1)	パッケージ サイズ(2)
TPS73801	DCQ (SOT-223、6)	6.5mm × 7.06mm

(1) 詳細については、*メカニカル、パッケージ、および注文情報*をご覧ください。
(2) パッケージ サイズ (長さ × 幅) は公称値であり、該当する場合はピンを含みます。



アプリケーション概略図

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4 Pin Configuration and Functions

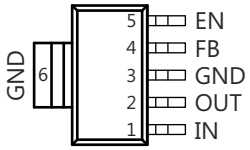


図 4-1. DCQ Package, 6-Pin SOT-223 (Top View)

表 4-1. Pin Functions

PIN		TYPE	DESCRIPTION
NO.	NAME		
1	IN	—	Input. Power is supplied to the device through the IN pin. A bypass capacitor is required on this pin if the device is more than six inches away from the main input filter capacitor. In general, the output impedance of a battery rises with frequency, so including a bypass capacitor in battery-powered circuits is advisable. A bypass capacitor (ceramic) in the range of 1 µF to 10 µF is sufficient. The TPS73801 regulators are designed to withstand reverse voltages on the IN pin with respect to ground and the OUT pin. In the case of a reverse input, which can happen if a battery is plugged in backwards, the device acts as if there is a diode in series with the input. There is no reverse current flow into the regulator, and no reverse voltage appears at the load. Both the device and the load are protected.
2	OUT	—	Output. The output supplies power to the load. A minimum output capacitor (ceramic) of 10 µF is required to prevent oscillations. Larger output capacitors are required for applications with large transient loads to limit peak voltage transients.
3	GND	—	Ground
4	FB	IN	Feedback. This pin is the input to the error amplifier. This pin is internally clamped to ±7 V. FB has a bias current of 3 µA that flows into the pin. The FB pin voltage is 1.21 V referenced to ground, and the output voltage range is 1.21 V to 20 V.
5	EN	IN	Enable. The EN pin is used to put the TPS73801 regulators into a low-power shutdown state. The output is off when the EN pin is pulled low. The EN pin can be driven either by 5-V logic or open-collector gate, normally several microamperes, and the EN pin current, typically 3 µA. If unused, the EN pin must be connected to the IN pin. The device is in the low-power shutdown state if the EN pin is not connected.
6	GND	—	Ground

5 Specifications

5.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)(1)

			MIN	MAX	UNIT
V_{IN}	Input voltage	IN	–20	20	V
		OUT	–20	20	
		Input-to-output differential (2)	–20	20	
		FB	–7	7	
		EN	–20	20	
t_{short}	Output short-circuit duration			Indefinite	
T_J	Operating virtual-junction temperature		–40	125	°C
T_{stg}	Storage temperature		–65	150	°C

(1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
(2) Absolute maximum input-to-output differential voltage cannot be achieved with all combinations of rated IN pin and OUT pin voltages. With the IN pin at 20 V, the OUT pin cannot be pulled below 0 V. The total measured voltage from IN to OUT cannot exceed ±20 V.

5.2 ESD Ratings

			VALUE	UNIT
$V_{(ESD)}$	Electrostatic discharge	Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins (1)	2000	V
		Charged device model (CDM), per JEDEC specification JESD22-C101, all pins (2)	1000	

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

5.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
V_{IN}	Input voltage range	V_{OUT} + VDO	20	V
V_{IH}	EN high-level input voltage	2	20	V
V_{IL}	EN low-level input voltage		0.25	V
T_J	Recommended operating junction temperature range	–40	125	°C

5.4 Thermal Information

THERMAL METRIC (1)		TPS73801 DCQ (SOT-223) 6 PINS	UNIT
$R_{\theta JA}$	Junction-to-ambient thermal resistance	50.5	°C/W
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	31.1	°C/W
$R_{\theta JB}$	Junction-to-board thermal resistance	5.1	°C/W
ψ_{JT}	Junction-to-top characterization parameter	1.0	°C/W
ψ_{JB}	Junction-to-board characterization parameter	5.0	°C/W
$R_{\theta JC(bot)}$	Junction-to-case (bottom) thermal resistance	—	°C/W

(1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application note.

5.5 Electrical Characteristics

over operating temperature range T_J = –40°C to 125°C (unless otherwise noted)(1)

PARAMETER		TEST CONDITIONS		T_J	MIN	TYP (10)	MAX	UNIT
V_{IN}	Input voltage (2) (3)			25°C	2.2	1.9	20	V
V_{FB}	FB pin voltage (2) (4)	TPS73801	V_{IN} = 2.21 V, I_{LOAD} = 1 mA	25°C	1.192	1.21	1.228	V
			V_{IN} = 2.5 V to 20 V, I_{LOAD} = 1 mA to 1.0A	Full range	1.174	1.21	1.246	
	Line regulation	TPS73801 (2)	ΔV_{IN} = 2.21 V to 20 V, I_{LOAD} = 1 mA	Full range		1.5	5	mV
	Load regulation	TPS73801 (2)	V_{IN} = 2.5 V, ΔI_{LOAD} = 1 mA to 1.0 A	25°C		2	8	mV
				Full range			18	
V_{DO}	Dropout voltage (3) (6) (5) V_{IN} = $V_{OUT(NOMINAL)}$	I_{LOAD} = 1 mA		25°C		0.02	0.06	V
				Full range			0.10	
		I_{LOAD} = 100 mA		25°C		0.1	0.17	
				Full range			0.22	
		I_{LOAD} = 500 mA		25°C		0.19	0.27	
				Full range			0.35	
		I_{LOAD} = 1.0 A		25°C		0.24	0.30	
				Full range			0.40	
I_{GND}	GND pin current (5) (7) V_{IN} = $V_{OUT(NOMINAL)}$ + 1	I_{LOAD} = 0 mA		Full range		1	1.5	mA
		I_{LOAD} = 1 mA		Full range		1.1	1.6	
		I_{LOAD} = 100 mA		Full range		3.8	5.5	
		I_{LOAD} = 500 mA		Full range		15	25	
		I_{LOAD} = 1.0 A		Full range		35	80	
V_N	Output voltage noise	C_{OUT} = 10 µF, I_{LOAD} = 1.0 A, B_W = 10 Hz to 100 kHz		25°C		45		μV_{RMS}
I_{FB}	FB pin bias current (2) (8)			25°C		3	10	µA
V_{EN}	Shutdown threshold	V_{OUT} = OFF to ON		Full range		0.9	2	V
		V_{OUT} = ON to OFF		Full range	0.25	0.75		
I_{EN}	$\overline{EN}$ pin current	V_{EN} = 0 V		25°C		0.01	1	µA
		V_{EN} = 20 V		25°C		3	30	
	Quiescent current in shutdown	V_{IN} = 6 V, V_{EN} = 0 V		25°C		0.01	1	µA
PSRR	Ripple rejection	V_{IN} – V_{OUT} = 1.5 V (avg), V_{RIPPLE} = 0.5 V_{P-P}, f_{RIPPLE} = 120 Hz, I_{LOAD} = 0.75 A		25°C	55	63		dB
I_{CL}	Current limit	V_{IN} = 7 V, V_{OUT} = 0 V		25°C		2		A
		V_{IN} = $V_{OUT(NOMINAL)}$ + 1		Full range	1.6			
I_{REV}	Input reverse leakage current	V_{IN} = –20 V, V_{OUT} = 0 V		Full range			1	mA
I_{RO}	Reverse output current (9)	TPS73801	V_{OUT} = 1.21 V, V_{IN} < 1.21 V	25°C		300	600	µA

(1) The TPS73801 regulators are tested and specified under pulse load conditions such that T_J is approximately equal to T_A. The TPS73801 is fully tested at T_A = 25°C. Performance at –40°C and 125°C is specified by design, characterization, and correlation with statistical process controls.
(2) The TPS73801 is tested and specified for these conditions with the FB pin connected to the OUT pin.
(3) Dropout voltages are limited by the minimum input voltage specification under some output voltage and load conditions.
(4) Operating conditions are limited by maximum junction temperature. The regulated output voltage specification does not apply for all possible combinations of input voltage and output current. When operating at maximum input voltage, the output current range must be limited. When operating at maximum output current, the input voltage range must be limited.
(5) To satisfy requirements for minimum input voltage, the TPS73801 is tested and specified for these conditions with an external resistor divider (two 4.12-kΩ resistors) for an output voltage of 2.4 V. The external resistor divider adds a 300-µA DC load on the output.
(6) Dropout voltage is the minimum input to output voltage differential needed to maintain regulation at a specified output current. In dropout, the output voltage is equal to: V_{IN} – $V_{DROPOUT}$.

(7) GND pin current is tested with V_{IN} = ($V_{OUT(NOMINAL)}$ + 1 V) and a current source load. The GND pin current decreases at higher input voltages.
(8) FB pin bias current flows into the FB pin.
(9) Reverse output current is tested with the IN pin grounded and the OUT pin forced to the rated output voltage. This current flows into the OUT pin and out the GND pin.
(10) Typical values represent the likely parametric nominal values determined at the time of characterization. Typical values depend on the application and configuration and can vary over time. Typical values are not specified on production material.

5.6 Typical Characteristics

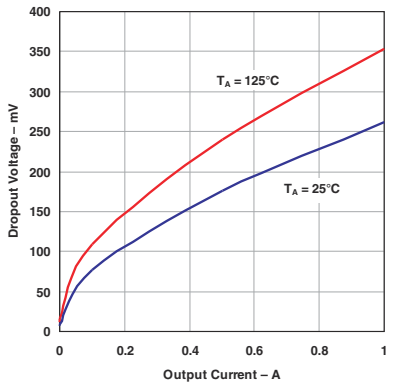


図 5-1. Dropout Voltage vs Output Current

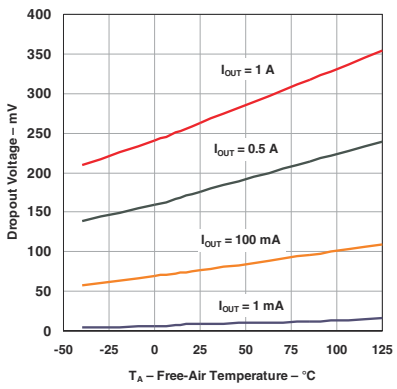
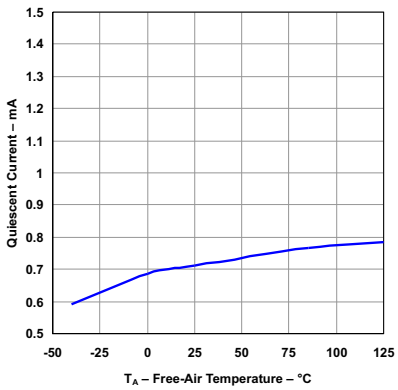
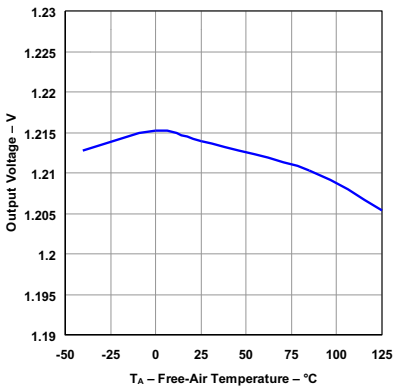


図 5-2. Dropout Voltage vs Temperature



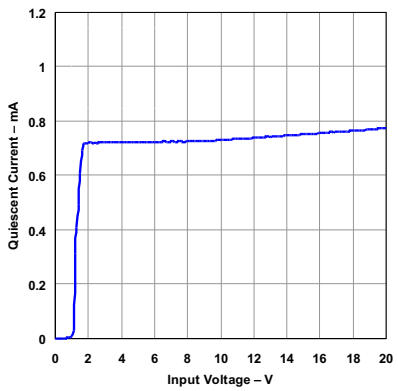
V_{IN} = 6 V, I_{OUT} = 0 A, V_{EN} = V_{IN}

図 5-3. Quiescent Current vs Temperature



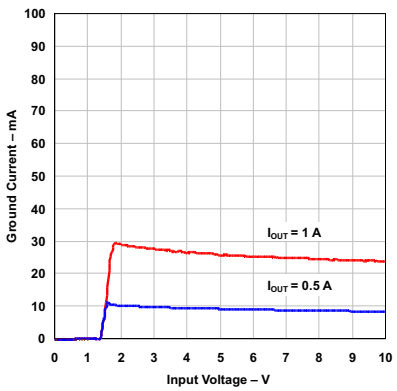
V_{IN} = 6 V, I_{OUT} = 1 mA

図 5-4. Output Voltage vs Temperature



T_J = 25°C, R_{OUT} = 4.3 kΩ, V_{EN} = V_{IN}

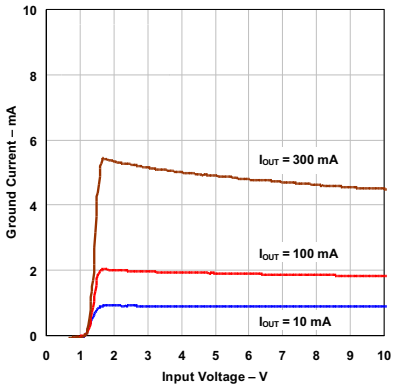
図 5-5. Quiescent Current vs Input Voltage



T_J = 25°C, V_{OUT} = 1.21 V, V_{EN} = V_{IN}

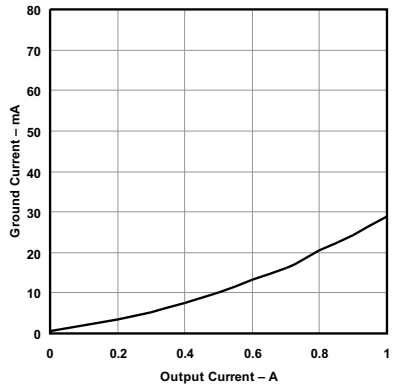
図 5-6. Ground Current vs Input Voltage

5.6 Typical Characteristics (continued)



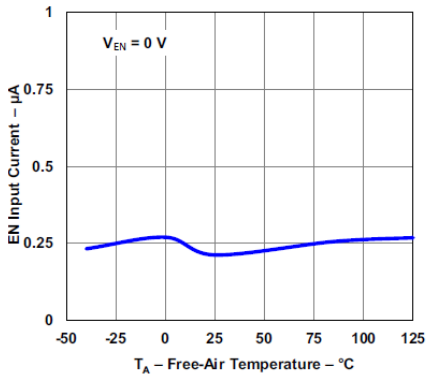
T_J = 25°C, V_{OUT} = 1.21 V, V_{EN} = V_{IN}

図 5-7. Ground Current vs Input Voltage



V_{IN} = V_{OUT}(nom) + 1

図 5-8. Ground Current vs Output Current



V_{EN} = 0 V

図 5-9. EN Input Current vs Temperature

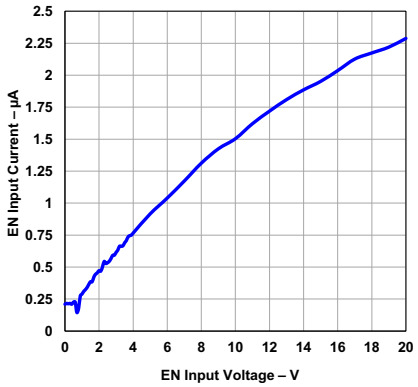
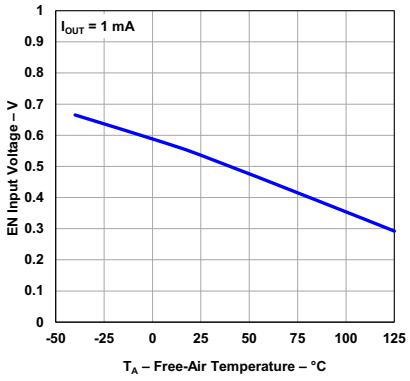
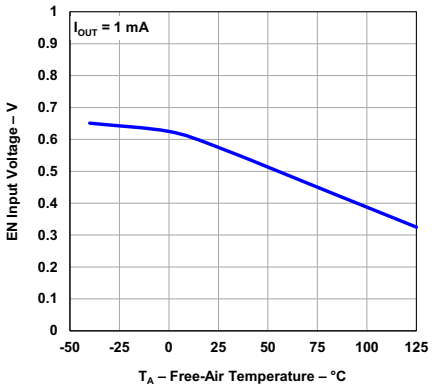


図 5-10. EN Input Current vs EN Input Voltage



I_{OUT} = 1 mA

図 5-11. EN Threshold (Off to On) vs Temperature



I_{OUT} = 1 mA

図 5-12. EN Threshold (On to Off) vs Temperature

5.6 Typical Characteristics (continued)

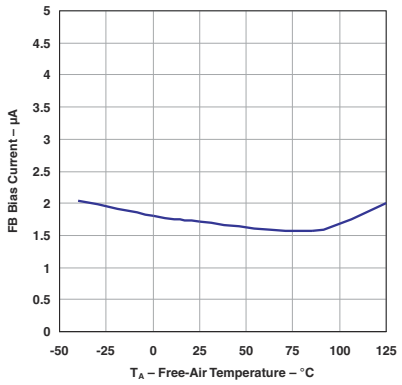
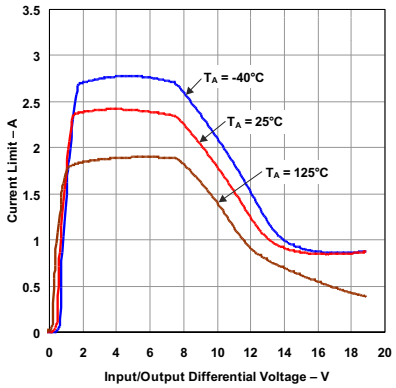
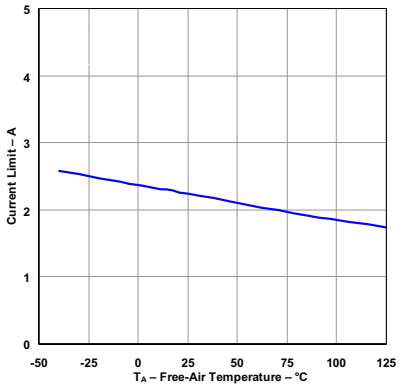


図 5-13. Fb Bias Current vs Temperature



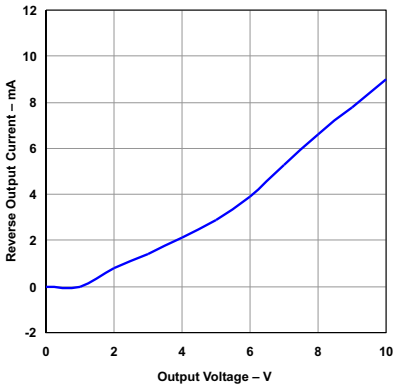
ΔV_{OUT} = 100 mV

図 5-14. Current Limit vs Input/Output Differential Voltage



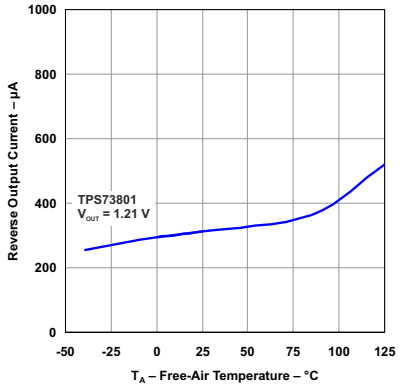
V_{IN} = 7 V, V_{OUT} = 0 V

図 5-15. Current Limit vs Temperature



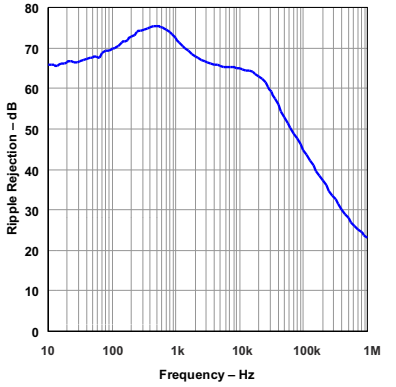
T_J = 25°C, V_{IN} = 0 V, current flows into OUT pin

図 5-16. Reverse Output Current vs Output Voltage



V_{IN} = 0 V

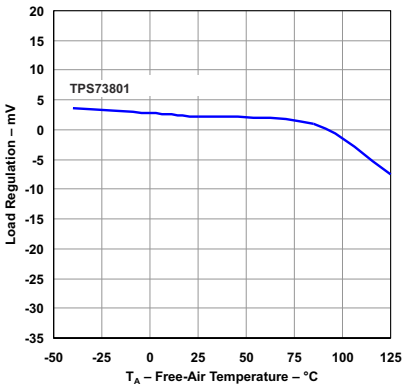
図 5-17. Reverse Output Current vs Temperature



V_{IN} = 2.7 V, V_{RIPPLE} = 0.05 V_{PP}, I_{OUT} = 750 mA, C_{IN} = 0, C_{OUT} = 10 µF (ceramic), T_A = 25°C

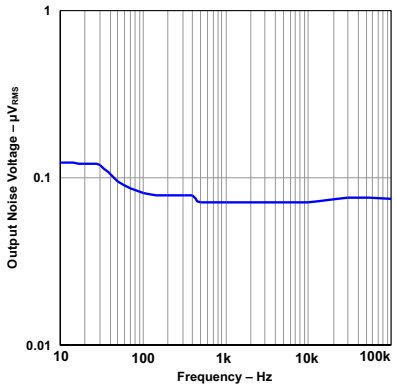
図 5-18. Ripple Rejection vs Frequency

5.6 Typical Characteristics (continued)



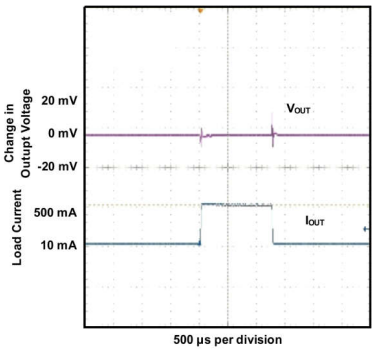
I_{OUT} = 1 A

図 5-19. Load Regulation vs Temperature



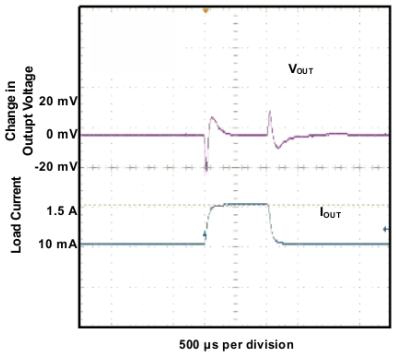
C_{OUT} = 10 µF (ceramic), I_{OUT} = 1 A

図 5-20. Output Noise Voltage vs Frequency



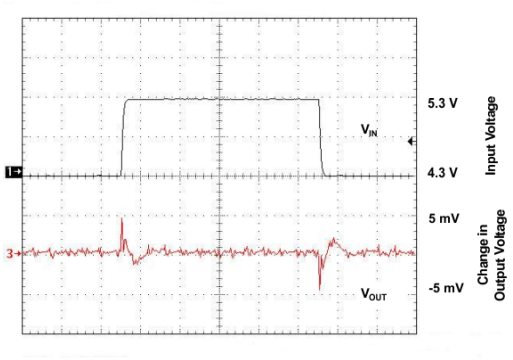
V_{IN} = 4.3 V, C_{IN} = 10 µF, C_{OUT} = 10 µF (ceramic)

図 5-21. Load Transient Response



V_{IN} = 4.3 V, C_{IN} = 10 µF, C_{OUT} = 10 µF (ceramic)

図 5-22. Load Transient Response



I_{OUT} = 1.5 A, C_{IN} = 10 µF, C_{OUT} = 10 µF (ceramic)

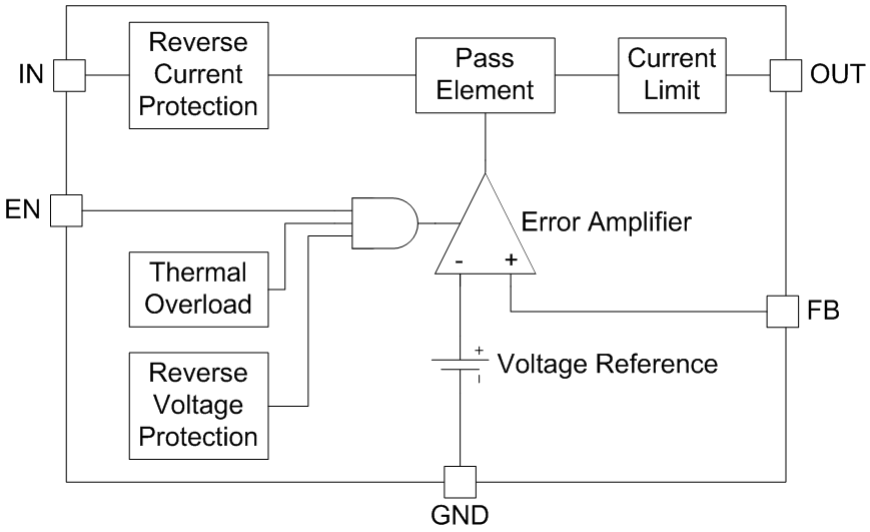
図 5-23. Line Transient Response

6 Detailed Description

6.1 Overview

The TPS73801 is a 1.0-A LDO regulator optimized for fast transient response. The device is capable of supplying 1.0 A at a dropout voltage of 300 mV. The low operating quiescent current (1 mA) drops to less than 1 µA in shutdown. In addition to the low quiescent current, the TPS73801 regulators incorporate several protection features which make them well suited for use in battery-powered systems. The device is protected against both reverse input and reverse output voltages. In battery-backup applications where the output can be held up by a backup battery when the input is pulled to ground, the TPS73801 acts as if it has a diode in series with its output and prevents reverse current flow. Additionally, in dual-supply applications where the regulator load is returned to a negative supply, the output can be pulled below ground by as much as 20 V and still allow the device to start and operate.

6.2 Functional Block Diagram



6.3 Feature Description

6.3.1 Adjustable Operation

The TPS73801 has an adjustable output voltage range of 1.21 V to 20 V. The output voltage is set by the ratio of two external resistors as shown in 図 6-1. The device maintains the voltage at the FB pin at 1.21 V referenced to ground. The current in R1 is then equal to (1.21 V / R1), and the current in R2 is the current in R1 plus the FB pin bias current. The FB pin bias current, 3 µA at 25 °C, flows through R2 into the FB pin. The output voltage can be calculated using the formula shown in 式 1. The value of R1 must be less than 4.17 kΩ to minimize errors in the output voltage caused by the FB pin bias current. In shutdown the output is turned off, and the divider current is zero.

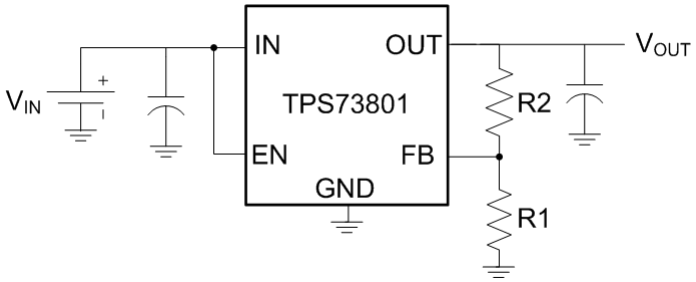


図 6-1. Adjustable Operation

The output voltage can be set using the following equations:

$$V_{OUT} = 1.21\ V\left(1 + \frac{R2}{R1}\right) + I_{FB} \times R2 \quad (1)$$

$$V_{FB} = 1.21\ V \quad (2)$$

$$I_{FB} = 3\ \mu A \text{ at } 25\ °C \quad (3)$$

Output Range = 1.21 to 20 V (4)

6.3.2 Fixed Operation

The TPS73801 can be used in a fixed voltage configuration. By connecting the FB pin to OUT the TPS73801 regulates the output to 1.21 V. During fixed voltage operation, the FB pin can be used for a Kelvin connection if routed separately to the load. This connection allows the regulator to compensate for voltage drop across parasitic resistances (RP) between the output and the load. This compensation becomes more crucial with higher load currents.

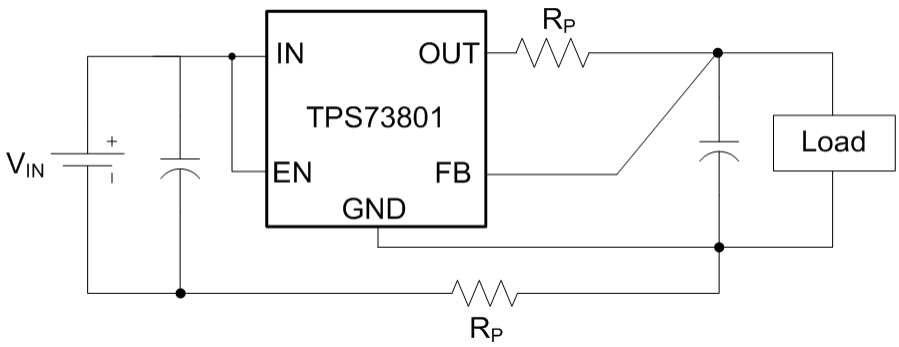


図 6-2. Kelvin Sense Connection

6.3.3 Overload Recovery

Like many device power regulators, the TPS73801 has safe operating area protection. The safe area protection decreases the current limit as input-to-output voltage increases and keeps the power transistor inside a safe operating region for all values of input-to-output voltage. The protection is designed to provide some output current at all values of input-to-output voltage up to the device breakdown.

When power is first turned on, as the input voltage rises, the output follows the input and allows the regulator to start up into very heavy loads. During start up, as the input voltage is rising, the input-to-output voltage differential is small, allowing the regulator to supply large output currents. With a high input voltage, a problem can occur wherein removal of an output short does not allow the output voltage to recover. Other regulators also exhibit this phenomenon, and thus is not unique to the TPS73801.

The problem occurs with a heavy output load when the input voltage is high and the output voltage is low. Common situations occur immediately after the removal of a short circuit or when the shutdown pin is pulled high after the input voltage has already been turned on. The load line for such a load can intersect the output current curve at two points. If this condition happens, there are two stable output operating points for the regulator. With this double intersection, the input power supply may need to be cycled down to zero and brought up again to make the output recover.

6.3.4 Output Voltage Noise

The TPS73801 regulators are designed to provide low output voltage noise over the 10-Hz to 100-kHz bandwidth while operating at full load. Output voltage noise is typically 40 nV/$\sqrt{\text{Hz}}$ over this frequency bandwidth for the TPS73801. For higher output voltages (generated by using a resistor divider), the output voltage noise is

gained up accordingly. This results in RMS noise over the 10-Hz to 100-kHz bandwidth of 14 μVRMS for the TPS73801.

Higher values of output voltage noise may be measured when care is not exercised with regards to circuit layout and testing. Crosstalk from nearby traces can induce unwanted noise onto the output of the TPS73801. Power-supply ripple rejection must also be considered; the TPS73801 regulators do not have unlimited power-supply rejection and pass a small portion of the input noise through to the output.

6.3.5 Protection Features

The TPS73801 regulators incorporate several protection features that make them well suited for use in battery-powered circuits. In addition to the normal protection features associated with monolithic regulators, such as current limiting and thermal limiting, the device is protected against reverse input voltages, reverse output voltages, and reverse voltages from output to input.

Current limit protection and thermal overload protection are intended to protect the device against current overload conditions at the output of the device. For normal operation, the junction temperature must not exceed 125°C.

The input of the device withstands reverse voltages of 20 V. Current flow into the device is limited to less than 1 mA (typically less than 100 μA), and no negative voltage appears at the output. The device protects both itself and the load in such situations. This provides protection against batteries that can be plugged in backward.

The output of the TPS73801 can be pulled below ground without damaging the device. If the input is left open circuit or grounded, the output can be pulled below ground by 20 V. The output acts like an open circuit; no current flows out of the pin. If the input is powered by a voltage source, the output sources the short-circuit current of the device and protects itself by thermal limiting. In this case, grounding the EN pin turns off the device and stops the output from sourcing the short-circuit current.

The FB pin can be pulled above or below ground by as much as 7 V without damaging the device. If the input is left open circuit or grounded, the FB pin acts like an open circuit when pulled below ground and like a large resistor (typically 5 kΩ) in series with a diode when pulled above ground.

In situations where the FB pin is connected to a resistor divider that would pull the FB pin above its 7-V clamp voltage if the output is pulled high, the FB pin input current must be limited to less than 5 mA. For example, a resistor divider is used to provide a regulated 1.5-V output from the 1.21-V reference when the output is forced to 20 V. The top resistor of the resistor divider must be chosen to limit the current into the FB pin to less than 5 mA when the FB pin is at 7 V. The 13-V difference between OUT and FB pins divided by the 5-mA maximum current into the FB pin yields a minimum top resistor value of 2.6 kΩ.

In circuits where a backup battery is required, several different input/output conditions can occur. The output voltage can be held up while the input is either pulled to ground, pulled to some intermediate voltage, or is left open circuit. When the IN pin of the TPS73801 is forced below the OUT pin or the OUT pin is pulled above the IN pin, input current typically drops to less than 2 μA. This condition can happen if the input of the device is connected to a discharged (low voltage) battery and the output is held up by either a backup battery or a second regulator circuit. The state of the EN pin has no effect on the reverse output current when the output is pulled above the input.

6.4 Device Functional Modes

See the device modes in 表 6-1.

表 6-1. Device Modes

EN	DEVICE STATE
H	Regulated voltage
L	Shutdown

7 Application and Implementation

注

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7.1 Application Information

7.1.1 Output Capacitance and Transient Response

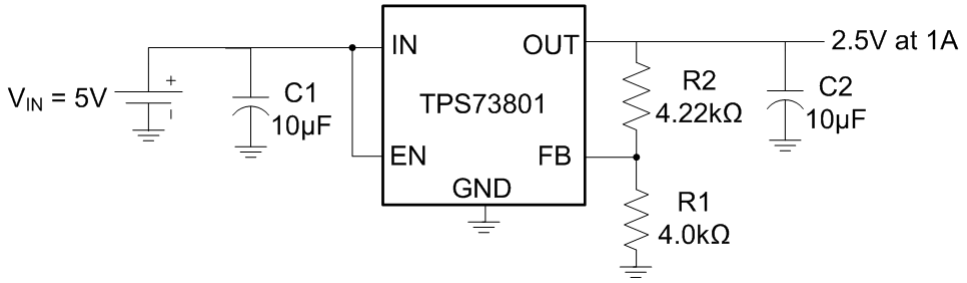
The TPS73801 regulators are designed to be stable with a wide range of output capacitors. The ESR of the output capacitor affects stability, most notably with small capacitors. A minimum output capacitor of 10 µF with an ESR of 3 Ω or less is recommended to prevent oscillations. Larger values of output capacitance can decrease the peak deviations and provide improved transient response for larger load current changes. Bypass capacitors, used to decouple individual components powered by the TPS73801, increase the effective output capacitor value.

Extra consideration must be given to the use of ceramic capacitors. Ceramic capacitors are manufactured with a variety of dielectrics, each with different behavior over temperature and applied voltage. The most common dielectrics used are Z5U, Y5V, X5R and X7R. The Z5U and Y5V dielectrics are good for providing high capacitances in a small package, but exhibit strong voltage and temperature coefficients. When used with a 5-V regulator, a 10-µF Y5V capacitor can exhibit an effective value as low as 1 µF to 2 µF over the operating temperature range. The X5R and X7R dielectrics result in more stable characteristics and are more suitable for use as the output capacitor. The X7R type has better stability across temperature, while the X5R is less expensive and is available in higher values.

Voltage and temperature coefficients are not the only sources of problems. Some ceramic capacitors have a piezoelectric response. A piezoelectric device generates voltage across its terminals due to mechanical stress, similar to the way a piezoelectric accelerometer or microphone works. For a ceramic capacitor, the stress can be induced by vibrations in the system or thermal transients.

7.2 Typical Application

This section highlights some of the design considerations when implementing this device in various applications.



All capacitors are ceramic.

図 7-1. Adjustable Output Voltage Operation

7.2.1 Design Requirements

表 7-1 shows the design parameters for this application.

表 7-1. Design Parameters

DESIGN PARAMETER	EXAMPLE VALUE
Input voltage (V_{IN})	5.0 V
Output voltage (V_{OUT})	2.5 V
Output current (I_{OUT})	0 to 1 A
Load regulation	1%

7.2.2 Detailed Design Procedure

The TPS73801 has an adjustable output voltage range of 1.21 V to 20 V. The output voltage is set by the ratio of two external resistors R1 and R2, as shown in 図 7-1. The device maintains the voltage at the FB pin at 1.21 V referenced to ground. The current in R1 is then equal to (1.21 V / R1), and the current in R2 is the current in R1 plus the FB pin bias current. The FB pin bias current, 3 µA at 25°C, flows through R2 into the FB pin. The output voltage can be calculated using 式 5.

$$V_{OUT} = 1.21\,V\left(1+\frac{R2}{R1}\right)+I_{FB}\times R2 \tag{5}$$

The value of R1 must be less than 4.17 kΩ to minimize errors in the output voltage caused by the FB pin bias current. In shutdown the output is turned off, and the divider current is zero. For an output voltage of 2.50 V, R1 is set to 4.0 kΩ. R2 is then found to be 4.22 kΩ using the equation above.

$$V_{OUT} = 1.21V\left(1+\frac{4.22k\Omega}{4.0k\Omega}\right)+3\mu A\times 4.22k\Omega \tag{6}$$

$$V_{OUT} = 2.50\ V \tag{7}$$

The adjustable device is tested and specified with the FB pin tied to the OUT pin for an output voltage of 1.21 V. Specifications for output voltages greater than 1.21 V are proportional to the ratio of the desired output voltage to 1.21 V: V_{OUT} / 1.21 V. For example, load regulation for an output current change of 1 mA to 1.5 A is –2 mV (typ) at V_{OUT} = 1.21 V. At V_{OUT} = 2.50 V, the typical load regulation is:

$$(2.50\ V / 1.21\ V)(-2\ mV) = -4.13\ mV \tag{8}$$

図 7-2 shows the actual change in output is about 3 mV for a 1-A load step. The maximum load regulation at 25°C is –8 mV. At V_{OUT} = 2.50 V, the maximum load regulation is:

$$(2.50\ V / 1.21\ V)(-8\ mV) = -16.53\ mV \tag{9}$$

Because 16.53 mV is only 0.7% of the 2.5 V output voltage, the load regulation meets the design requirements.

7.2.3 Application Curve

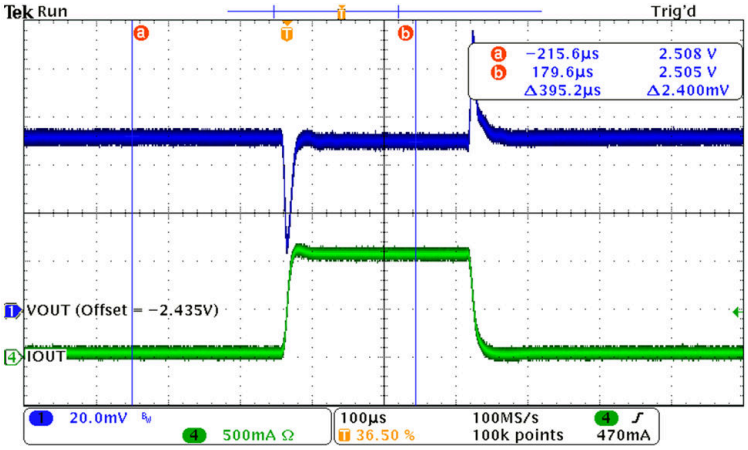


図 7-2. 1-A Load Transient Response

7.3 Power Supply Recommendations

The device is designed to operate with an input voltage supply up to 20 V. The minimum input voltage must provide adequate headroom greater than the dropout voltage for the device to have a regulated output. If the input supply is noisy, additional input capacitors with low ESR can help improve the output noise performance.

7.4 Layout

7.4.1 Layout Guidelines

1. For best performance, all traces must be as short as possible.
2. Use wide traces for IN, OUT, and GND to minimize the parasitic electrical effects.
3. A minimum output capacitor of 10 µF with an ESR of 3 Ω or less is recommended to prevent oscillations. X5R and X7R dielectrics are preferred.
4. Place the output capacitor as close as possible to the OUT pin of the device.
5. The tab of the DCQ package must be connected to ground.

7.4.1.1 Thermal Considerations

The power handling capability of the device is limited by the recommended maximum operating junction temperature (125°C). The power dissipated by the device is made up of two components:

1. Output current multiplied by the input/output voltage differential: $I_{OUT}(V_{IN} – V_{OUT})$
2. GND pin current multiplied by the input voltage: $I_{GND}V_{IN}$

The GND pin current can be found using the GND pin current graphs in the *Typical Characteristics*. Power dissipation is equal to the sum of the two components listed above.

The TPS73801 series regulators have internal thermal limiting designed to protect the device during overload conditions. For continuous normal conditions, the recommended maximum operating junction temperature is 125°C. Careful consideration must be given to all sources of thermal resistance from junction to ambient. Additional heat sources mounted nearby must also be considered.

7.4.1.1.1 Calculating Junction Temperature

Example: Given an output voltage of 3.3 V, an input voltage range of 4 V to 6 V, an output current range of 0 mA to 500 mA, and a maximum ambient temperature of 50°C, what is the operating junction temperature?

The power dissipated by the device is equal to:

$$I_{OUT(MAX)}(V_{IN(MAX)} – V_{OUT}) + I_{GND}(V_{IN(MAX)}) \quad (10)$$

where:

- $I_{OUT(MAX)}$ = 500 mA
- $V_{IN(MAX)}$ = 6 V
- I_{GND} at (I_{OUT} = 500 mA, V_{IN} = 6 V) = 10 mA

So,

$$P = 500\ mA \times (6\ V - 3.3\ V) + 10\ mA \times 6\ V = 1.41\ W \quad (11)$$

The thermal resistance of the DCQ package is 50.5°C/W. So the junction temperature rise above ambient is approximately equal to:

$$1.41W \times 50.5°C/W = 71.2°C \quad (12)$$

The junction temperature rise can then be added to the maximum ambient temperature to find the operating junction temperature (T_J):

$$T_J = 50°C + 71.2°C = 121.2°C \quad (13)$$

7.4.2 Layout Example

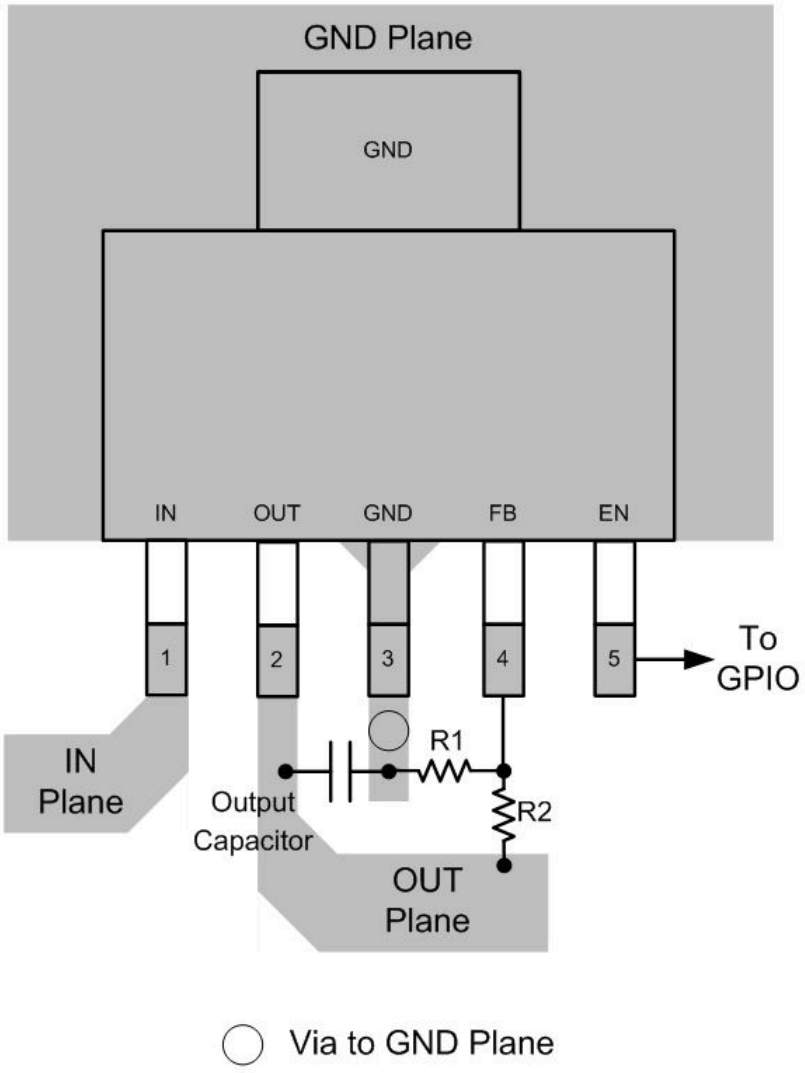


図 7-3. SOT-223 Layout Example (DCQ)

8 Device and Documentation Support

8.1 ドキュメントの更新通知を受け取る方法

ドキュメントの更新についての通知を受け取るには、www.tij.co.jp のデバイス製品フォルダを開いてください。[通知] をクリックして登録すると、変更されたすべての製品情報に関するダイジェストを毎週受け取ることができます。 変更の詳細については、改訂されたドキュメントに含まれている改訂履歴をご覧ください。

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8.5 用語集

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9 Revision History

資料番号末尾の英字は改訂を表しています。その改訂履歴は英語版に準じています。

Changes from Revision C (July 2015) to Revision D (June 2025)	Page
• ドキュメント全体にわたって表、図、相互参照の採番方法を更新	1
• 「アプリケーション」セクションを変更	1
• *簡略化されたアプリケーション*の図のタイトルを変更	1
• Changed 300 mA to 300 µA in footnote 5 of *Electrical Characteristics* table	5

Changes from Revision B (October 2014) to Revision C (July 2015)	Page
• Moved storage temperature to the *Absolute Maximum Ratings*	4
• Changed *Handling Ratings* to *ESD Ratings* and updated units from kV to V	4

10 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

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PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package | Pins	Package qty | Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
TPS73801DCQR	Active	Production	SOT-223 (DCQ) | 6	2500 | LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	PS73801
TPS73801DCQR.A	Active	Production	null (null) |	2500 | LARGE T&R	-	NIPDAU	Level-2-260C-1 YEAR	See TPS73801DCQR	PS73801
TPS73801DCQRG4	Active	Production	SOT-223 (DCQ) | 6	2500 | LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	PS73801
TPS73801DCQRG4.A	Active	Production	null (null) |	2500 | LARGE T&R	-	NIPDAU	Level-2-260C-1 YEAR	See TPS73801DCQRG4	PS73801

(1) **Status:** For more details on status, see our product life cycle.

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

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(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

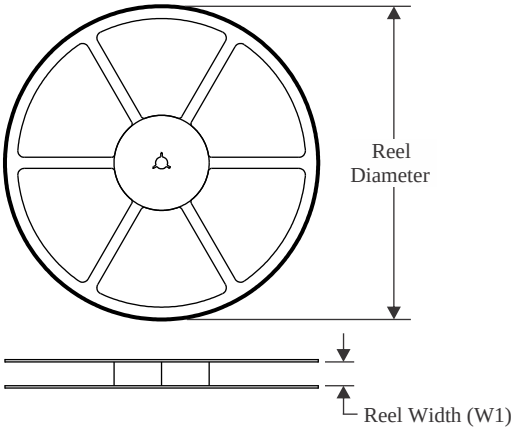
(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

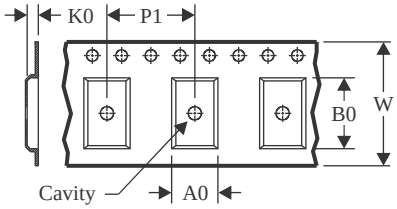
Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

TAPE AND REEL INFORMATION

REEL DIMENSIONS

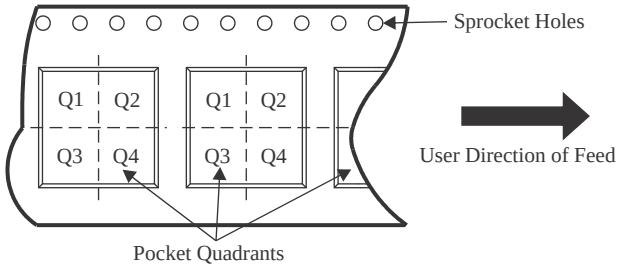


TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

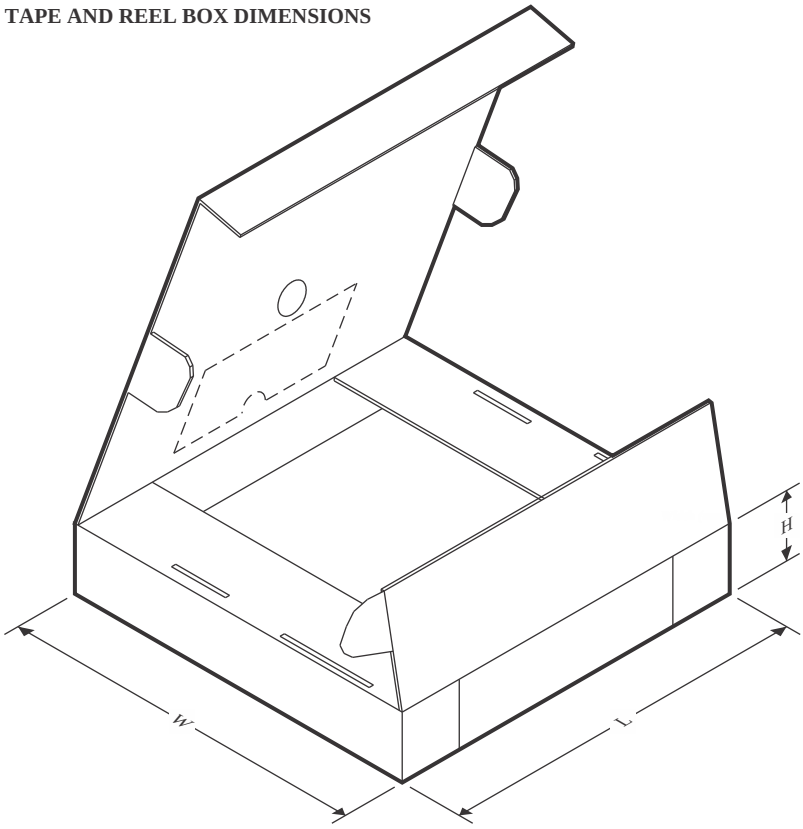
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS73801DCQR	SOT-223	DCQ	6	2500	330.0	12.4	7.1	7.45	1.88	8.0	12.0	Q3
TPS73801DCQRG4	SOT-223	DCQ	6	2500	330.0	12.4	7.1	7.45	1.88	8.0	12.0	Q3

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

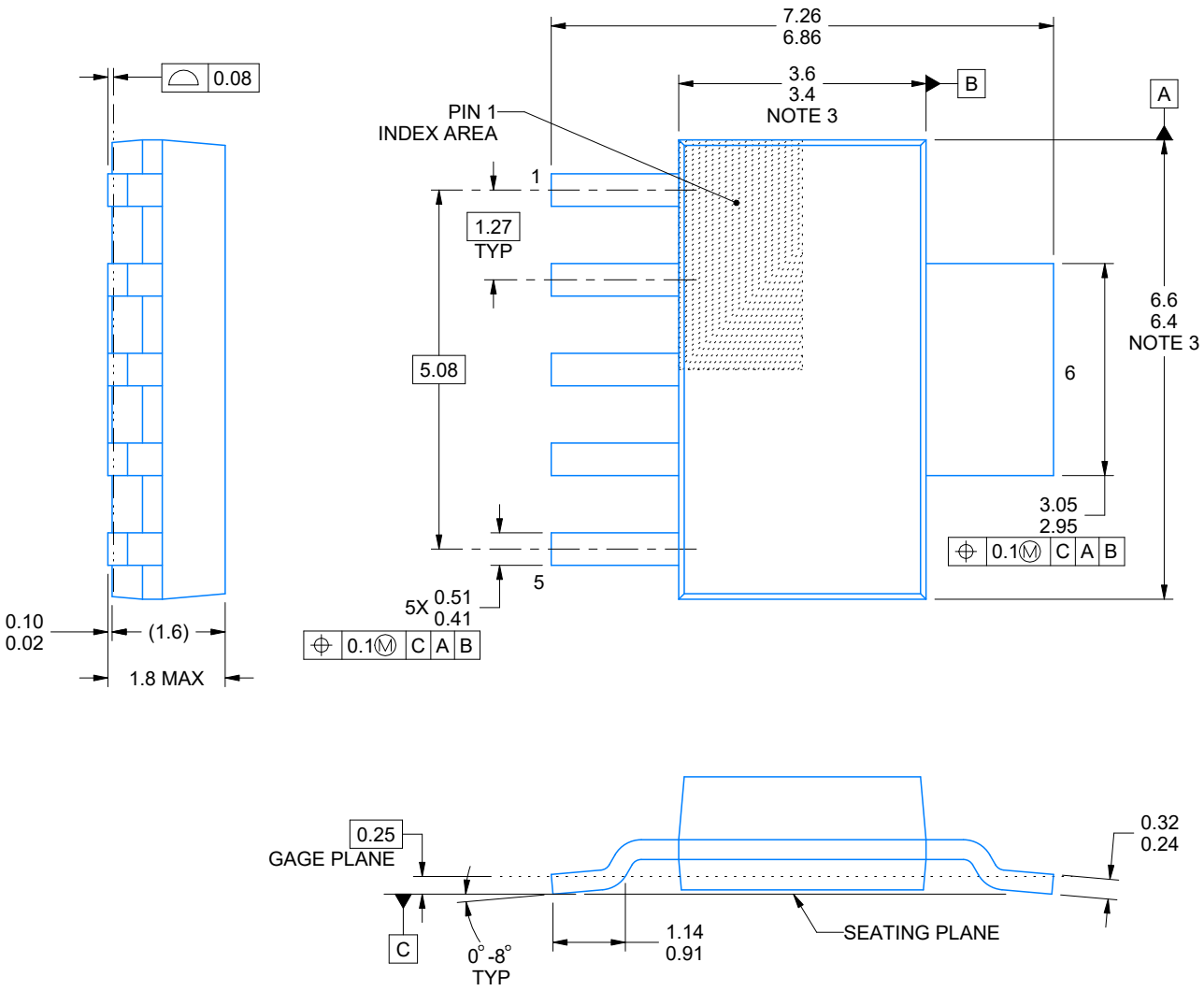
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPS73801DCQR	SOT-223	DCQ	6	2500	346.0	346.0	29.0
TPS73801DCQRG4	SOT-223	DCQ	6	2500	346.0	346.0	29.0

PACKAGE OUTLINE

DCQ0006A

SOT - 1.8 mm max height

PLASTIC SMALL OUTLINE



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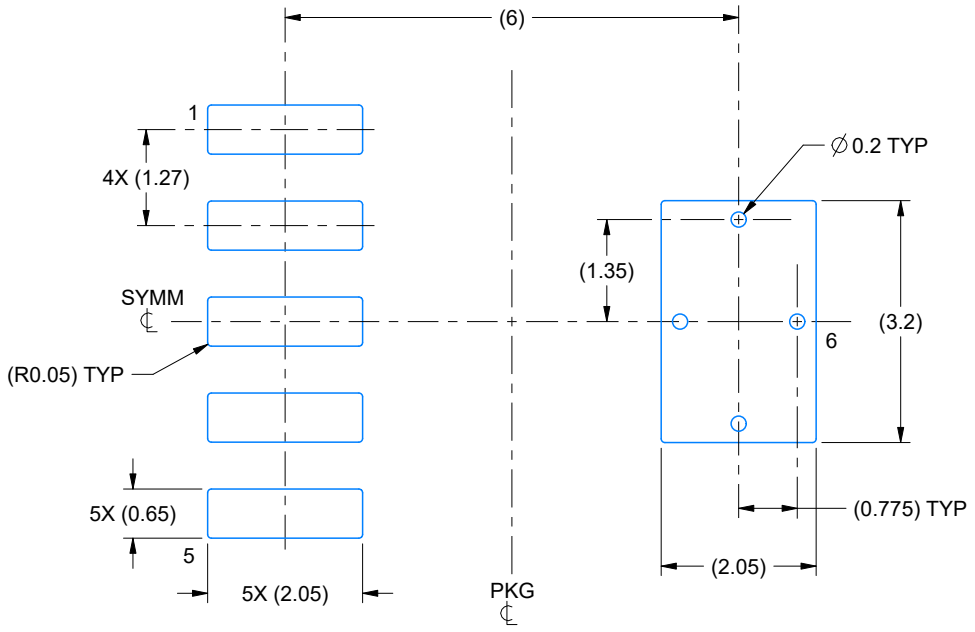
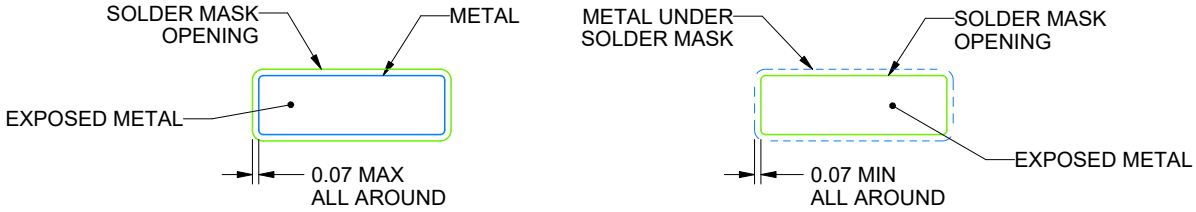
NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE: 10X



SOLDER MASK DETAILS

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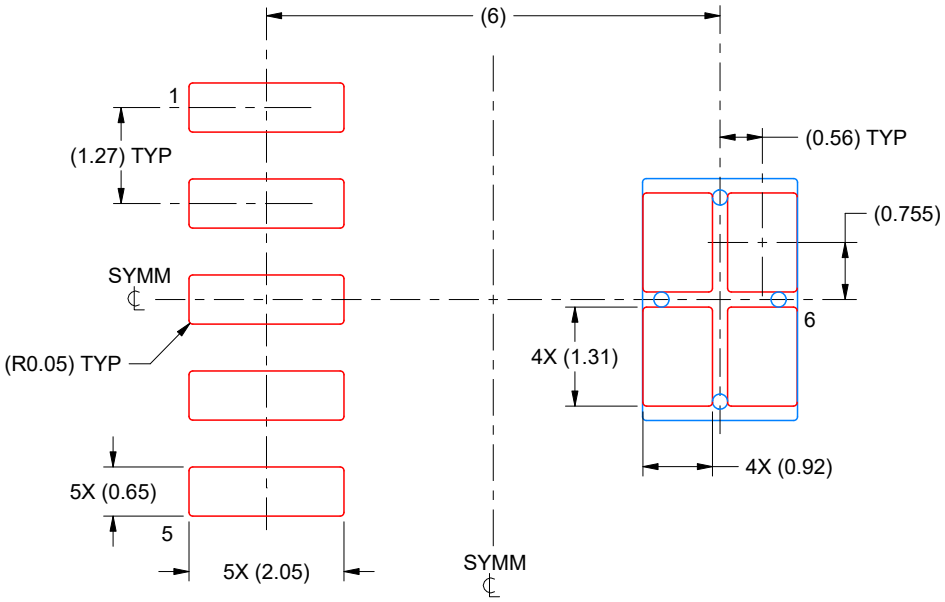
NOTES: (continued)

4. Publication IPC-7351 may have alternate designs.
5. Solder mask tolerances between and around signal pads can vary based on board fabrication site.
6. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE: 10X

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NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

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